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FDS86242

N-Channel PowerTrench[®] MOSFET 150 V, 4.1 A, 67 m Ω

Features

- Max $r_{DS(on)}$ = 67 m Ω at V_{GS} = 10 V, I_D = 4.1 A
- Max r_{DS(on)} = 98 mΩ at V_{GS} = 6 V, I_D = 3.3 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- RoHS Compliant

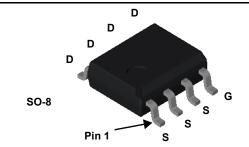


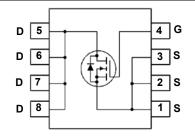
General Description

This N -Channel MOSFET is produced using ON Semiconductor's advanced Power T rench[®] process that has been optimized for $r_{DS(on)}$, switching per formance and ruggedness.

Applications

- DC/DC converters and Off-Line UPS
- Distributed Power Architectures and VRMs
- Primary Switch for 24V and 48V Systems
- High Voltage Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units		
V _{DS}	Drain to Source Voltage			150	V		
V _{GS}	Gate to Source Voltage			±20	V		
ID	Drain Current -Continuous			4.1	•		
	-Pulsed			20	A		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	40	mJ		
P _D	Power Dissipation	T _C = 25 °C	(Note 1)	5.0	w		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

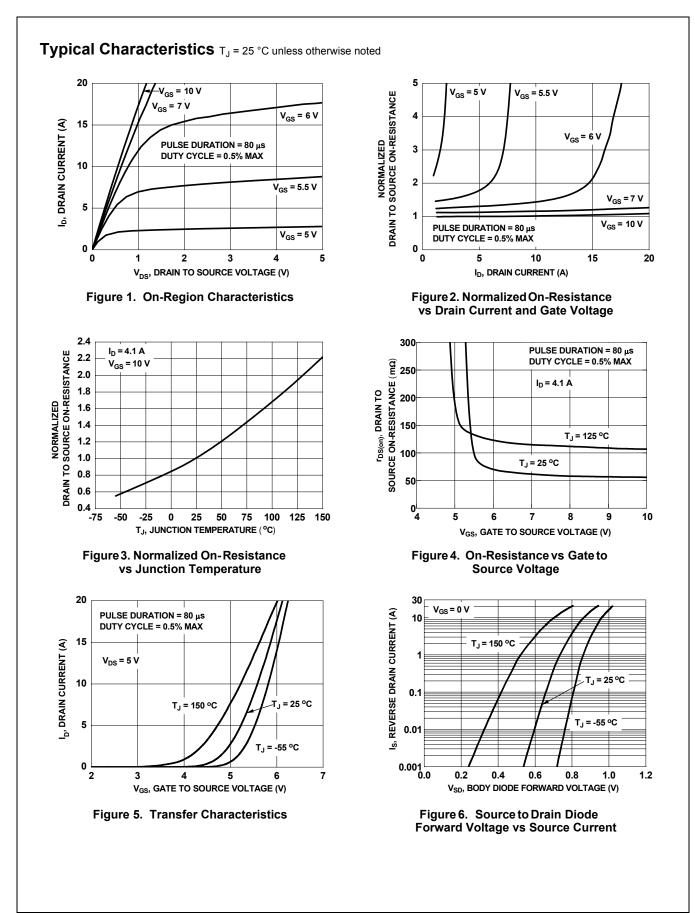
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS86242	FDS86242	SO-8	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperatur Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		104		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	3.5	4	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		-		-	-
ΔT_J	Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-10		mV/°C
		V _{GS} = 10 V, I _D = 4.1 A		56.3	67	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 3.3 A		73.8	98	
		V_{GS} = 10 V, I_{D} = 4.1 A, T_{J} = 125 °C		107	126	
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 4.1 \text{ A}$		11		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			570	760	pF
C _{oss}	Output Capacitance	$V_{\rm DS} = 75 \text{ V}, V_{\rm GS} = 0 \text{ V},$		64	85	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		2.9	5	pF
R _q	Gate Resistance			0.5		Ω
Switching	g Characteristics				L	
	Turn-On Delay Time			7.9	16	ns
t _{d(on)} t _r	Rise Time	V _{DD} = 75 V, I _D = 4.1 A,		1.5	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{\text{DD}} = 73 \text{ V}, \text{ ID} = 4.1 \text{ A},$ $V_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$		13	23	ns
t _f	Fall Time			2.8	10	ns
q Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0 V to 10 V		8.9	13	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V$,		4.9	7	nC
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 4.1 {\rm A}$		3.0	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			2.0		nC
	urce Diode Characteristics	<u> </u>				
Drain-Soi		1/2 = 0 1/2 = 410 (Note 2)		0.01	1.2	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 4.1 A $ (Note 2) $V_{GS} = 0 V, I_S = 2 A $ (Note 2)		0.81	1.3 1.2	V
t _{rr}	Reverse Recovery Time			61	98	ns
Q _{rr}	Reverse Recovery Charge	– I _F = 4.1 A, di/dt = 100 A/μs		71	114	nC
NOTES: . R _{θJA} is determ the user's boa	a) 50 °C/W when mounted or 2 oz copper para a) 50 °C/W when mounted or 1 in ² pad of 2 oz copper.			when mount		termined by

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%. 3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 9 A, V_{DD} = 135 V, V_{GS} = 10 V.

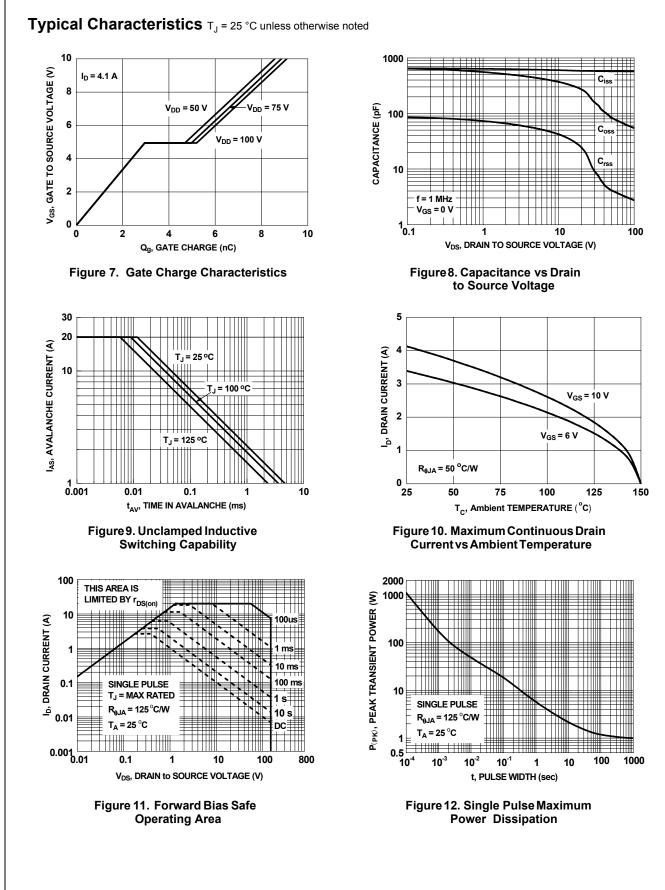
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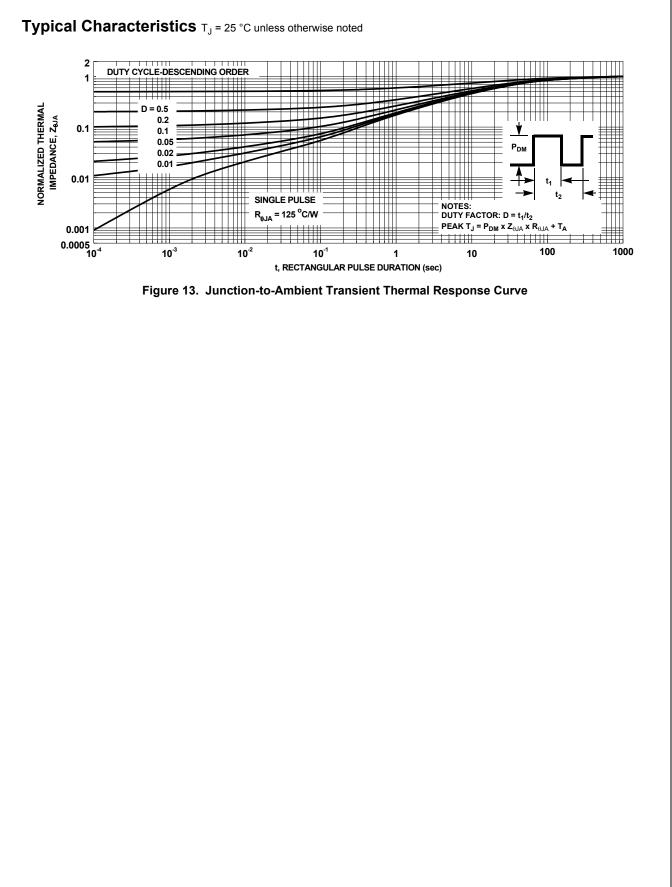
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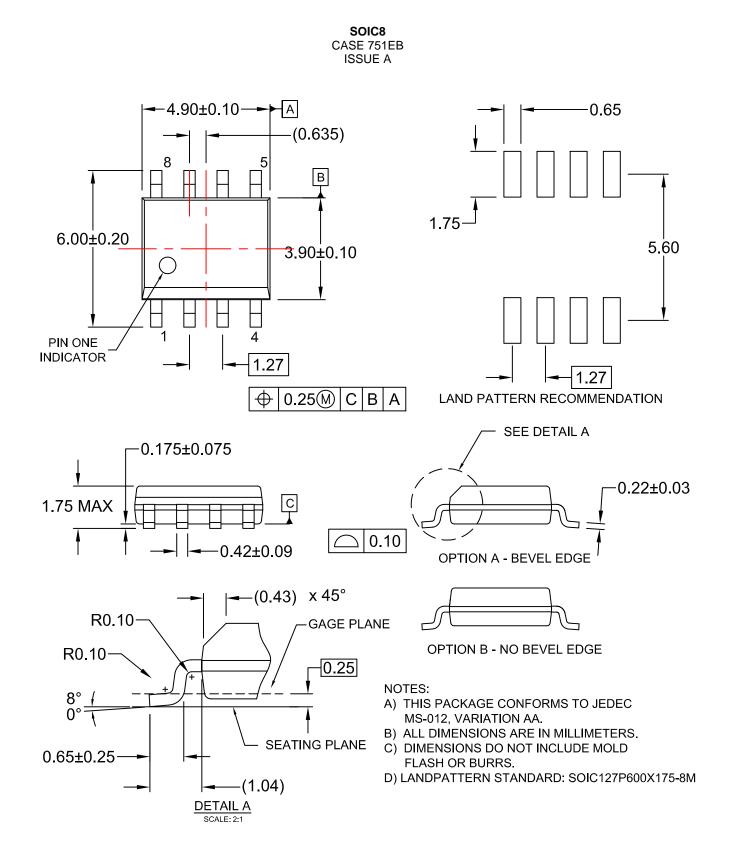


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